

EC8001 MEMS AND NEMS

DETAILED SYLLABUS

OBJECTIVES:

- To introduce the concepts of micro and nano electromechanical devices
- To know the fabrication process of Microsystems
- To know the design concepts of micro sensors and micro actuators
- To introduce the concepts of quantum mechanics and nano systems

UNIT I INTRODUCTION TO MEMS AND NEMS

Introduction to Design of MEMS and NEMS, Overview of Nano and Microelectromechanical Systems, Applications of Micro and Nanoelectromechanical systems, Materials for MEMS and NEMS: Silicon, silicon compounds, polymers, metals.

UNIT II MEMS FABRICATION TECHNOLOGIES

Photolithography, Ion Implantation, Diffusion, Oxidation, CVD, Sputtering Etching techniques, Micromachining: Bulk Micromachining, Surface Micromachining, LIGA.

UNIT III MICRO SENSORS

MEMS Sensors: Design of Acoustic wave sensors, Vibratory gyroscope, Capacitive Pressure sensors, Case study: Piezoelectric energy harvester

UNIT IV MICRO ACTUATORS

Design of Actuators: Actuation using thermal forces, Actuation using shape memory Alloys, Actuation using piezoelectric crystals, Actuation using Electrostatic forces, Case Study: RF Switch.

UNIT V NANO DEVICES

Atomic Structures and Quantum Mechanics, Shrodinger Equation, ZnO nanorods based NEMS device: Gas sensor.

REFERENCES:

1. Marc Madou, —Fundamentals of MicrofabricationII, CRC press 1997.
2. Stephen D. Senturia, II Micro system DesignII, Kluwer Academic Publishers,2001
3. Tai Ran Hsu, IIMEMS and Microsystems Design and ManufactureII, Tata Mcraw Hill, 2002.
4. Chang Liu, —Foundations of MEMSII, Pearson education India limited, 2006,
5. Sergey Edward Lyshevski, —MEMS and NEMS: Systems, Devices, and StructuresII CRC Press, 2002